AEC-Q101 Qualified

2.5V Drive Nch+Nch MOS FET QS6K1FRA

Structure

Silicon N-channel MOS FET

Features

- 1) Low on-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small and Surface Mount Package (TSMT6).

Application

Power switching, DC / DC converter.

TSMT6 Each lead has same dimensions Abbreviated symbol : K01

●External dimensions (Unit : mm)

Packaging specifications

	Package	Taping
Туре	Code	TR
	Basic ordering unit (pieces)	3000
QS6K1FRA	0	

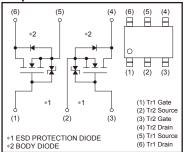
● Absolute maximum ratings (Ta=25°C)

<It is the same ratings for the Tr1 and Tr2>

Parameter		Symbol	Limits	Unit			
Drain-source voltage		V _{DSS}	30	V			
Gate-source voltage		V _{GSS}	12	V			
Dunin assent	Continuous	ID	±1.0	Α			
Drain current	Pulsed	I _{DP} *1	±4.0	Α			
Source current	Continuous	Is	0.8	Α			
(Body diode)	Pulsed	I _{SP} *1	4.0	Α			
Total power dissipation (Tc=25°C)		Pn *2	1.25	W / TOTAL			
		FD -	0.9	W / ELEMENT			
Channel temperature		Tch	150	°C			
Storage temperature		Tstg	-55 to +150	°C			
15 15 5 1 10							

^{*1} Pw≤10µs, Duty cycle≤1% *2 Mounted on a ceramic board

Equivalent circuit



A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded.

Thermal resistance

Parameter	Symbol	Limits	Unit	
Channel to ambient	Rth (ch-a)*	100	°C / W / TOTAL	
Charmer to ambient	Kill (Cli-a)	139	°C/W/ELEMENT	

^{*} Mounted on a ceramic board

●Electrical characteristics (Ta=25°C)

<It is the same characteristics for the Tr1 and Tr2>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	_	_	10	μΑ	Vgs=12V, Vps=0V
Drain-source breakdown voltage	V(BR) DSS	30	_	_	V	ID=1mA, VGS=0V
Zero gate voltage drain current	I _{DSS}	_	-	1	μА	V _{DS} =30V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	0.5	_	1.5	٧	V _{DS} =10V, I _D =1mA
Otatia dusia assuras au stata		_	170	238		I _D =1.0A, V _{GS} =4.5V
Static drain-source on-state resistance	R _{DS (on)} *	_	180	252	mΩ	I _D =1.0A, V _{GS} =4.0V
resistance		_	260	364		I _D =1.0A, V _{GS} =2.5V
Forward transfer admittance	Y _{fs} *	1.0	_	-	S	I _D =1.0A, V _{DS} =10V
Input capacitance	Ciss	_	77	_	pF	V _{DS} =10V
Output capacitance	Coss	_	25	_	pF	Vgs=0V
Reverse transfer capacitance	Crss	_	15	_	pF	f=1MHz
Turn-on delay time	t _{d (on)} *	_	7	_	ns	I _D =500mA, V _{DD} ≒15V
Rise time	tr *	_	7	_	ns	V _{GS} =4.5V
Turn-off delay time	t _{d (off)} *	_	15	_	ns	R _L =30.0Ω
Fall time	t _f *	_	6	_	ns	R _G =10Ω
Total gate charge	Qg *	_	1.7	2.4	nC	V _{DD} ≒15V
Gate-source charge	Q _{gs} *	_	0.4	_	nC	V _{GS} =4.5V
Gate-drain charge	Q _{gd} *	_	0.4	_	nC	I _D =1.0A

^{*}Pulsed

●Body diode characteristics (Source-Drain) (Ta=25°C)

<It is the same characteristics for the Tr1 and Tr2>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp *	-	-	1.2	V	Is=3.2A, Vgs=0V

^{*}Pulsed



Electrical characteristic curves

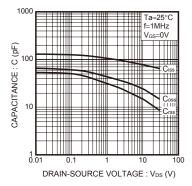


Fig.1 Typical Capacitance vs. Drain-Source Voltage

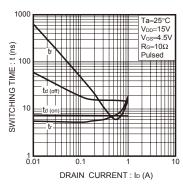


Fig.2 Switching Characteristics

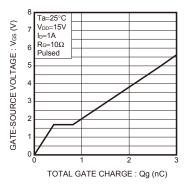


Fig.3 Dynamic Input Characteristics

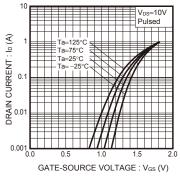


Fig.4 Typical Transfer Characteristics

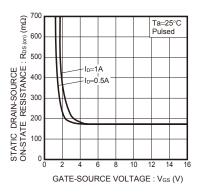


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

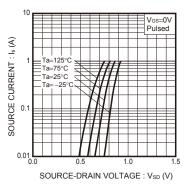


Fig.6 Source Current vs. Source-Drain Voltage

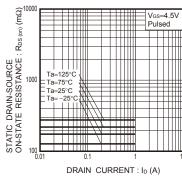


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (I)

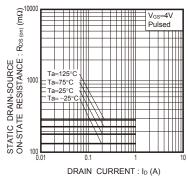


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (II)

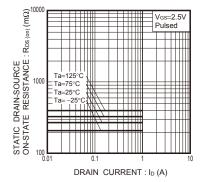


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (III)

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(Note1) Medical Equipment Classification of the Specific Applications

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JAPAN	APAN USA EU		CHINA				
CLASSⅢ	CLASSⅢ	CLASSIIb	CLASSIII				
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII				

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 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
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- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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